

Title (en)

Process for the after-treatment of plates, foils or strips and its application as substrate for offset printing plates

Title (de)

Verfahren zur Nachbehandlung von platten-, folien- oder bandförmigem Material, Träger aus derartigem Material und seine Verwendung für Offsetdruckplatten

Title (fr)

Procédé de post-traitement de plaques, feuilles ou bandes et son application comme support pour plaques d'impression

Publication

**EP 0683248 B1 19971217 (DE)**

Application

**EP 95107331 A 19950515**

Priority

DE 4417907 A 19940521

Abstract (en)

[origin: EP0683248A1] Plates which have been chemically, mechanically or electrochemically roughened are anodised and then treated in an aqueous solution of a pure and crystalline alkali metal silicate followed by rinsing in an ion-containing water.

IPC 1-7

**C25D 11/24**; **C25D 11/18**; **B41N 1/08**

IPC 8 full level

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CPC (source: EP KR US)

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